LI0402E600R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

100

40

20

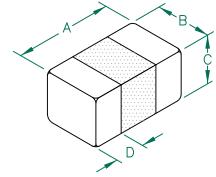
MPEDANCE

A 1.01 [.040] ± 0.18 [.007]

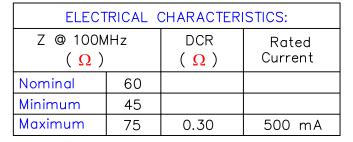
B 0.50 [.020] ± 0.20 [.008]

C 0.50 [.020] ± 0.20 [.008]

D 0.30 [.012] MAX.







NOTES: UNLESS OTHERWISE SPECIFIED

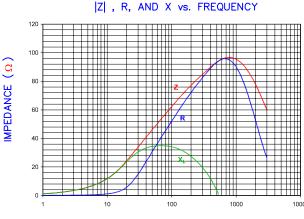
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 10,000 PCS/REEL, PAPER TAPE.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

FREQUENCY (MHz)

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

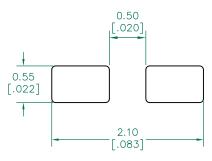
> - 100ma - 200ma

> > 400ma -500ma



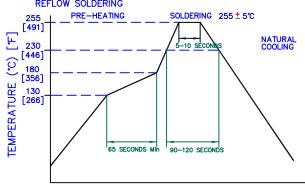
FREQUENCY (MHz)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 [.030] to this dimension.)

RECOMMENDED SOLDERING CONDITIONS **REFLOW SOLDERING** PRE-HEATING SOLDERING 255 ± 5°C



-										
ſ		DIMENSIONS ARE IN mm [INCHE		This print is the property of Lairo	d					
ſ					Tech. and is loaned in confidence			_		. ■"
ŀ					subject to return upon request a	ınd	Laird			
ŀ					with the understanding that no					
١					copies shall be made without the			\sim		
Ī					written consent of Laird Tech. All	ı	_			
ŀ			-	_	rights to design or invention are					
1 1	D	ADD OPERATING TEMPERATURE	08/05/13	uu u	reserved.					
١	-	UPDATE LAIRD LOGO AND REFLOW CURVE			PROJECT/PART NUMBER:	T	REV	PART TO	rPE:	DRAWN BY:
Ī	С	UPDATE COMPANY LOGO	07/09/08	JRK	LI0402E600R-10	- 1	D		FIDE	
		CHG REEL QTY FROM 4000, ADD PAPER	' ' '	JRK	LIU402E000K-10		ט	CO-FIRE		ТМВ
	В	TAPE TO NOTE #1 ADD ROHS SYMBOL	11/14/07							
		UPDATE COMPANY LOGO				CAL	E: N	TS SHEET:		
	Α	ORIGINAL DRAFT	04/05/04	TMB					2	of 2
					^{CAD}	00L	٠,	_		01 2
	REV	DESCRIPTION	DATE	INT	LIU+02E000K-10-D				l	

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3235